

April 2004 Revised May 2004

#### FSUSB11

# Low Power High Bandwidth USB Switch Dual SPDT Multiplexer/Demultiplexer

#### **General Description**

The FSUSB11 is a high performance Dual Single Pole Double Throw (SPDT) analog switch specially designed for the switching of both analog audio signal and USB 1.1 signals. The device features ultra low  $R_{ON}$  of  $1.3\Omega$  maximum at  $4.5 \mbox{V}_{CC}$  and  $4.3\Omega$  at  $2.7 \mbox{V}$  supply. High bandwidth and ultra low ON Resistance  $(R_{ON})$  make this switch to be able to pass both USB low and full speed signal with minimum signal distortion. The device is fabricated with sub-micron CMOS technology to achieve fast switching speeds and is designed for break-before-make operation. The select input is TTL level compatible.

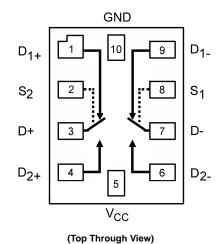
#### **Features**

- Space saving MicroPak<sup>™</sup> packaging (1.6mm x 2.1mm)
- USB 1.1 signal switching compliant
- -3db bandwidth: >350MHz
- Maximum 1.15 $\Omega$  ON Resistance at 4.5V V<sub>CC</sub> and 4 $\Omega$  for 2.7V supply
- $0.3\Omega$  maximum R<sub>ON</sub> flatness for +5V supply
- Broad V<sub>CC</sub> operating range: 1.65V to 5.5V
- Fast turn-on and turn-off time
- Break-before-make enable circuitry
- Over-voltage tolerant TTL compatible control input

#### **Ordering Code:**

Order	Package	Product Code	Package Description	Supplied As
Number	Number	Top Mark		
FSUSB11L10X	MAC010A	ET	10-Lead MicroPak, 1.6 mm x 2.1mm	5K Units on Tape and Reel

#### **Analog Symbols**



#### **Truth Table**

Control Input(s)	Function
L	D <sub>1</sub> Connected to D+/D-
Н	D <sub>2</sub> Connected to D+/D-

H = HIGH Logic Level L = LOW Logic Level

### **Pin Descriptions**

Pin Names	Function
D, D <sub>1</sub> , D <sub>2</sub>	Data Ports
S	Control Input

MicroPak™ is a trademark of Fairchild Semiconductor Corporation.

#### **Absolute Maximum Ratings**(Note 1)

Input Diode Current -50 mA
Switch Current 200 mA

Peak Switch Current (Pulsed at

1 ms duration, <10% Duty Cycle) 400 mA Storage Temperature Range ( $T_{STG}$ )  $-65^{\circ}$ C to +150 $^{\circ}$ C

Maximum Junction Temperature (T<sub>J</sub>)

Lead Temperature (T<sub>L</sub>)

Soldering, 10 seconds

**ESD** 

Human Body Model

# Recommended Operating Conditions

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

**Note 2:** The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

Note 3: Unused inputs must be held HIGH or LOW. They may not float.

#### DC Electrical Characteristics (All typical values are @ 25°C unless otherwise specified)

+150°C

+260°C

8000V

Symbol	Parameter	V <sub>CC</sub>	$T_A = +25^{\circ}C$		T <sub>A</sub> = -40°C to +85°C		Units	Conditions			
Symbol	Farameter	(V)	Min	Тур	Max	Min	Max	Units	Conditions		
V <sub>IH</sub>	Input Voltage High	2.7 to 3.6				2.0		V			
		4.5 to 5.5				2.4		v			
V <sub>IL</sub>	Input Voltage Low	2.7 to 3.6					0.6	V			
		4.5 to 5.5					8.0	v			
I <sub>IN</sub>	Control Input Leakage	2.7 to 3.6				-1.0	1.0	μА	V = 0V to V		
		4.5 to 5.5				-1.0	1.0	μА	$V_{IN} = 0V \text{ to } V_{CC}$		
I <sub>NO(OFF)</sub> ,	OFF-Leakage Current	5.5	-50.0		50.0	-100	100	nA	A = 1V, 4.5V		
I <sub>NC(OFF)</sub>	NC(OFF) of Port D <sub>1</sub> and D <sub>2</sub>		-50.0		50.0	-100	100	IIA	$B_0$ or $B_1 = 1V$ , 4.5V		
I <sub>A(ON)</sub>	ON Leakage Current	5.5	5.5	-50.0		50.0	-100	100	nA	A = 1V, 4.5V	
	of Port D			5.5	5.5	5.5	-50.0		30.0	-100	100
R <sub>ON</sub>	Switch ON Resistance	2.7		2.6	4.0		4.3	Ω	$I_{OUT} = 100 \text{ mA}, D_1 \text{ or } D_2 = 1.5 \text{V}$		
	(Note 4)	4.5		0.95	1.15		1.3	22	$I_{OUT} = 100 \text{ mA}, D_1 \text{ or } D_2 = 3.5 \text{V}$		
$\Delta R_{ON}$	ON Resistance Matching	2.7						Ω	$I_{OUT} = 100 \text{ mA}, D_1 \text{ or } D_2 = 1.5 \text{V}$		
	Between Channels (Note 5)	4.5		0.06	0.12		0.15	22	$I_{OUT} = 100 \text{ mA}, D_1 \text{ or } D_2 = 3.5 \text{V}$		
R <sub>FLAT(ON)</sub>	ON Resistance Flatness	2.7		1.4				Ω	$I_{OUT} = 100 \text{ mA}, D_1 \text{ or } D_2 = 0V, 0.75V, 1.5V$		
	(Note 6)	4.5		0.2	0.3		0.4	22	$I_{OUT} = 100 \text{ mA}, B_0 \text{ or } B_1 = 0V, 1V, 2V$		
Icc	Quiescent Supply Current	3.6					10.0	μА	V <sub>IN</sub> = 0V or V <sub>CC</sub> , I <sub>OUT</sub> = 0V		
		5.5					10.0	μΑ	VIN - OV OI VCC, IOUT = UV		

Note 4: ON Resistance is determined by the voltage drop between D and D<sub>n</sub> pins at the indicated current through the switch.

Note 5:  $\Delta R_{ON} = R_{ONmax} - R_{ONmin}$  measured at identical  $V_{CC}$ , temperature, and voltage.

Note 6: Flatness is defined as the difference between the maximum and minimum value of ON Resistance over the specified range of conditions.

# AC Electrical Characteristics (All typical value are @ 25°C unless otherwise specified)

Symbol	Parameter	V <sub>CC</sub>	Τ,	<sub>4</sub> = +25	°C	T <sub>A</sub> = -40°	C to +85°C	Units	Conditions	Figure
Cymbol	i arameter	(V)	Min	Тур	Max	Min	Max	Oilles	Conditions	Number
t <sub>ON</sub>	Turn ON Time	2.7 to 3.6			50.0		60.0	ns	$D_1$ or $D_2$ = 1.5V, $R_L$ = $50\Omega$ , $C_L$ = $35$ pF	Figure 1
		4.5 to 5.5			35.0		40.0	113	$D_1$ or $D_2 = 3.0$ V, $R_L = 50\Omega$ , $C_L = 35$ pF	i iguie i
t <sub>OFF</sub>	Turn OFF Time	2.7 to 3.6			20.0		30.0	ns	$D_1$ or $D_2 = 1.5$ V, $R_L = 50\Omega$ , $C_L = 35$ pF $D_1$ or $D_2 = 3.0$ V, $R_L = 50\Omega$ , $C_L = 35$ pF	Figure 1
		4.5 to 5.5			15.0		20.0	115	$D_1$ or $D_2=3.0V$ , $R_L=50\Omega$ , $C_L=35~pF$	
t <sub>B-M</sub>	Break-Before-Make	2.7 to 3.6				1.0		ns	$D_1$ or $D_2$ = 1.5V, $R_L$ = $50\Omega$ , $C_L$ = $35$ pF	Figure 2
	Time	4.5 to 5.5		20.0		1.0		113	$D_1 \text{ or } D_2 = 3.0 \text{V}, \ R_L = 50 \Omega, \ C_L = 35 \ \text{pF}$	i iguie z
Q	Charge Injection	2.7 to 3.6		20.0				рС	$C_L = 1.0 \text{ nF}, V_{GEN} = 0V,$	Figure 4
		4.5 to 5.5		10.0				ро	$R_{GEN} = 0\Omega$	
OIRR	OFF-Isolation	2.7 to 3.6		-70.0				dB	$f = 1MHz, R_1 = 50\Omega$	Figure 3
		4.5 to 5.5		-70.0				uв	1 - 11VII 12, INC - 3022	rigure 3
Xtalk	Crosstalk	2.7 to 3.6		-75.0				dB	$f = 1MHz, R_1 = 50\Omega$	Eiguro 2
		4.5 to 5.5		-75.0				uБ	1 = 1MHZ, R <sub>L</sub> = 5002	Figure 3
BW	-3db Bandwidth	2.7 to 3.6		350				MU-	B - 500	F: 0
		4.5 to 5.5		350				IVITIZ	$R_L = 50\Omega$	Figure 6

#### **USB Related AC Electrical Characteristics**

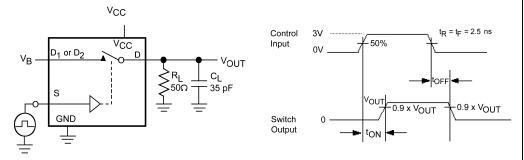
(All typical value are @25°C unless otherwise specified)

Symbol	Parameter	V <sub>CC</sub>	T <sub>A</sub> = +25°C			Units	Conditions	Figure	
Symbol	raiailletei	(V)	Min	Тур	Min	Units	Conditions	Number	
t <sub>SKEW</sub>	Skew	2.7 to 3.6		0.15		ns $R_S = 39\Omega$ , $C_L = 50 \text{ pF}$ $t_R = t_F = 12 \text{ns}$		Figure 7	
		4.5 to 5.5		0.15		115	$t_R = t_F = 12$ ns	rigule /	
t <sub>M</sub>	Rising/Fall Time	2.7 to 3.6			10.0	%	at 12Mbps	Figure 7	
	Mismatch	4.5 to 5.5			10.0	/6	(Duty Cycle = 50%)	i iguie i	
tJ	Total Jitter	2.7 to 3.6		1.7		ns	$R_S = 39\Omega$ , $C^L = 50$ pF, $t_R = t_F = 12$ ns at	Figure 7	
		4.5 to 5.5		1.6		113	12Mbps (PRBS = 2 <sup>15</sup> – 1)	i igule /	

# Capacitance

Symbol	Parameter	V <sub>CC</sub>		$T_A = +25^{\circ}C$		Units	Conditions	
- Cyllibor	randictor	(V)	Min	Тур	Max	0	Conditions	
C <sub>IN</sub>	Control Pin Input Capacitance	0.0		3.5		pF	f = 1MHz (see Figure 5)	
C <sub>OFF</sub>	C <sub>OFF</sub> D <sub>n</sub> Port OFF Capacitance			12.0		pF	f = 1MHz (see Figure 5)	
C <sub>ON</sub>	D Port ON Capacitance	4.5		55.0		pF	f = 1MHz (see Figure 5)	

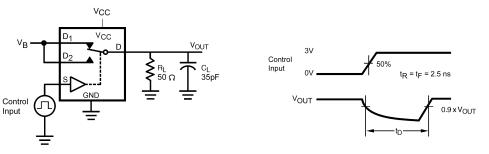
# AC Loading and Waveforms



 $\mathbf{C}_{\mathbf{L}}$  includes Fixture and Stray Capacitance

Logic Input Waveforms Inverted for Switches that have the Opposite Logic Sense

FIGURE 1. Turn-On/Turn-Off Timing



**C**<sub>L</sub> Includes Fixture and Stray Capacitance

FIGURE 2. Break-Before-Make Timing

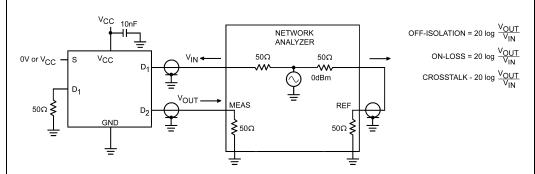


FIGURE 3. OFF Isolation and Crosstalk

# AC Loading and Waveforms (Continued)

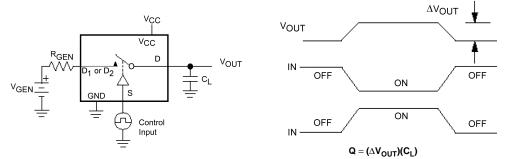


FIGURE 4. Charge Injection

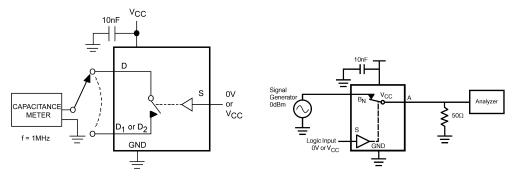


FIGURE 5. ON/OFF Capacitance Measurement Setup

FIGURE 6. Bandwidth

FIGURE 7. Skew Test

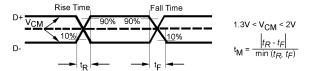
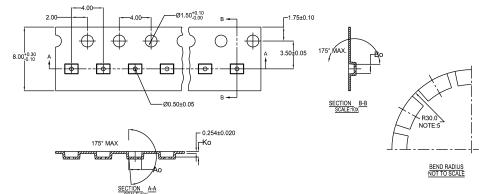


FIGURE 8. Rise/Fall Time Mismatch Test

# **Tape and Reel Specification**

Tape Format For Micropak 10

rape i ormat i or wit	biopak io			
Package Tape		Number	Cavity	Cover Tape
Designator	Section	Cavities	Status	Status
	Leader (Start End)	125 (typ)	Empty	Sealed
L10X	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed



10	300056	2.30±0.05	1.78±0.05	0.68±0.05
8	300038	1.78±0.05	1.78±0.05	0.68±0.05
6	300033	1.60±0.05	1.15±0.05	0.70±0.05
LEAD TYPE	STOCK#	Ao	Во	Ko

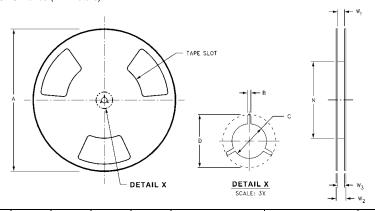
NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ACCUMULATED 50 SPROCKETS, SPROCKET HOLE PITCH IS 200.00 ±0.30MM
- 2. NO INDICATED CORNER RADIUS IS 0.127MM
- 3. CAMBER NOT TO EXCEED 1MM IN 100MM
- 4. SMALLEST ALLOWABLE BENDING RADIUS
- 5. POCKET POSITION RELATIVE TO SPROCKET HOLE MEASURED AS TRUE POSITION OF POCKET, NOT POCKET HOLE



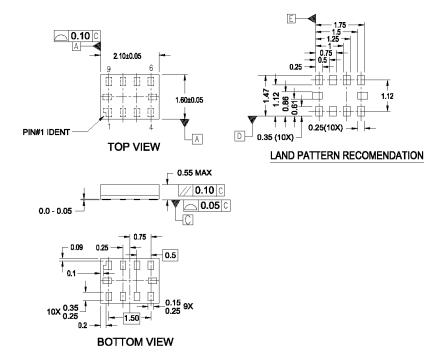
SCALE: 6X

#### **REEL DIMENSIONS** inches (millimeters)



Tape Size	Α	В	С	D	N	W1	W2	W3
8 mm	7.0	0.059	0.512	0.795	2.165	0.331 + 0.059/-0.000	0.567	W1 + 0.078/-0.039
0 111111	(177.8)	(1.50)	(13.00)	(20.20)	(55.00)	(8.40 + 1.50/-0.00)	(14.40)	(W1 + 2.00/-1.00)

#### Physical Dimensions inches (millimeters) unless otherwise noted



#### NOTES:

- A. JEDEC PACKAGE REGISTRATION IS ANTICIPATED.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES CONFORMS TO ASME Y14.5M, 1994.

#### MAC010ARevA

10-Lead MicroPak, 1.6 mm x 2.1mm Package Number MAC010A

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